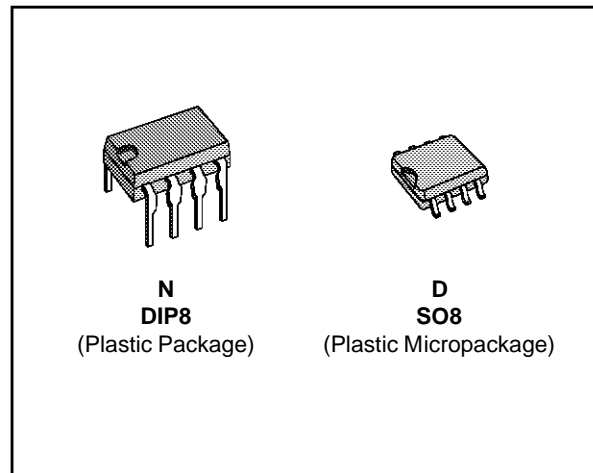


LOW POWER DUAL CMOS OPERATIONAL AMPLIFIERS

- EXCELLENT PHASE MARGIN ON CAPACITIVE LOADS
- SYMETRICAL OUTPUT CURRENTS
- LOW OUTPUT DYNAMIC IMPEDANCE
- THE TRANSFER FUNCTION IS LINEAR
- PIN TO PIN COMPATIBLE WITH STANDARD DUAL OP-AMPS (TL082 -LM358)
- STABLE AND LOW OFFSET VOLTAGE
- THREE INPUT OFFSET VOLTAGE SELECTIONS



ORDER CODES

Part Number	Temperature Range	Package	
		N	D
TS27M2C/AC/BC	0°C, +70°C	●	●
TS27M2I/AI/BI	-40°C, +125°C	●	●
TS27M2M/AM/BM	-55°C, +125°C	●	●

Example : TS27M2ACN

27M2-01.TBL

DESCRIPTION

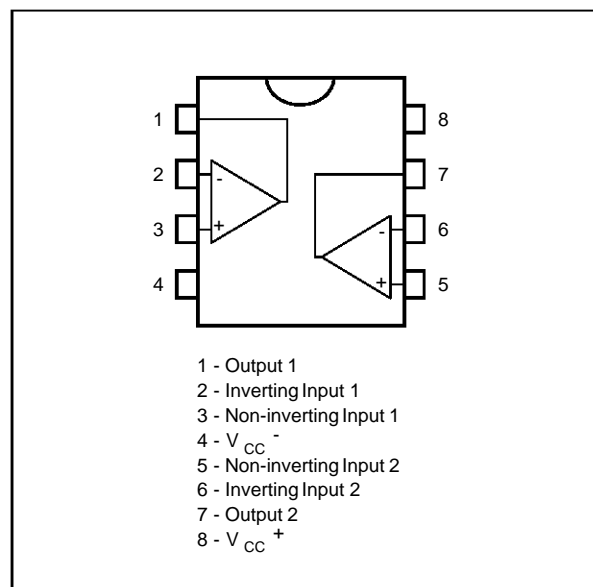
The TS272 series are low cost, low power dual operational amplifiers designed to operate with single or dual supplies. These operational amplifiers use the SGS-THOMSON silicon gate LIN MOS process giving them an excellent consumption-speed ratio. These series are ideally suited for low consumption applications.

Three power consumptions are available allowing to have always the best consumption-speed ratio :

- $I_{CC} = 10\mu\text{A}/\text{amp.}$: TS27L2 (very low power)
- $I_{CC} = 150\mu\text{A}/\text{amp.}$: TS27M2 (low power)
- $I_{CC} = 1\text{mA}/\text{amp.}$: TS272 (high speed)

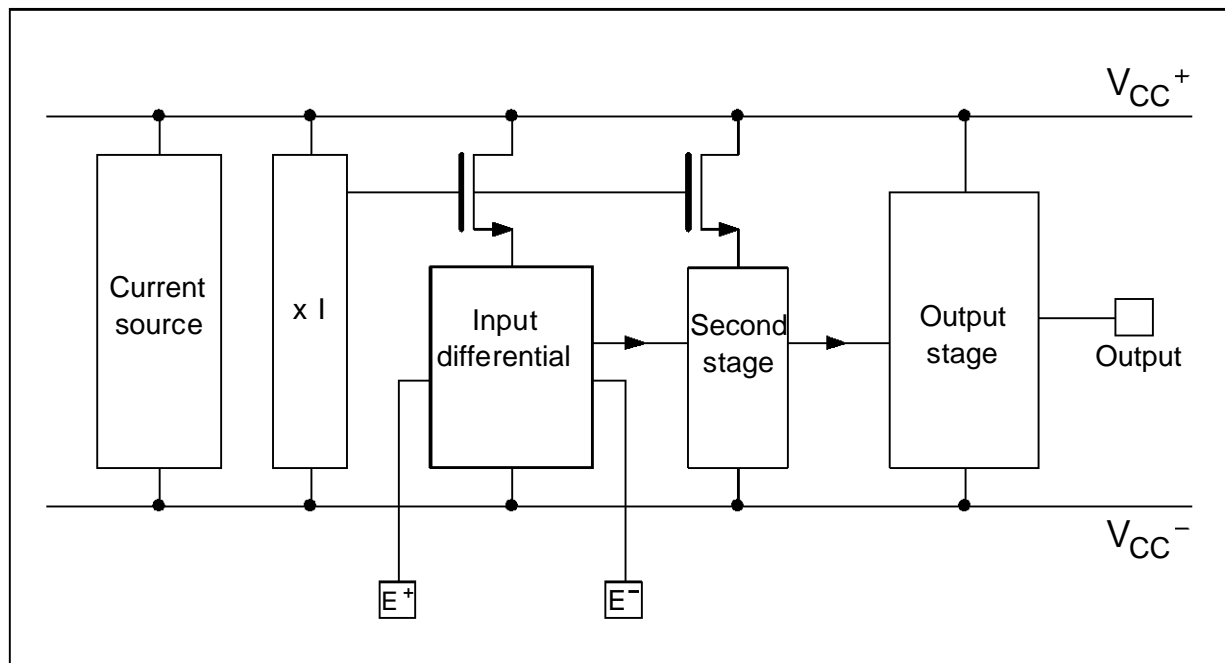
These CMOS amplifiers offer very high input impedance and extremely low input currents. The major advantage versus JFET devices is the very low input currents drift with temperature (see figure 2).

PIN CONNECTIONS (top view)



27M2-01.EPS

BLOCK DIAGRAM



27M2-02.EPS

MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}^+	Supply Voltage - (note 1)	18	V
V_{id}	Differential Input Voltage - (note 2)	± 18	V
V_i	Input Voltage - (note 3)	-0.3 to 18	V
I_O	Output Current for $V_{CC}^+ \geq 15V$	± 30	mA
I_{in}	Input Current	± 5	mA
T_{oper}	Operating Free-Air Temperature Range	TS27M2C/AC/BC TS27M2I/AI/BI TS27M2M/AM/BM 0 to +70 -40 to +125 -55 to +125	$^{\circ}C$
T_{stg}	Storage Temperature Range	-65 to +150	$^{\circ}C$

27M2-02.TBL

- Notes :**
1. All voltage values, except differential voltage, are with respect to network ground terminal.
 2. Differential voltages are at the non-inverting input terminal with respect to the inverting input terminal.
 3. The magnitude of the input and the output voltages must never exceed the magnitude of the positive supply voltage.

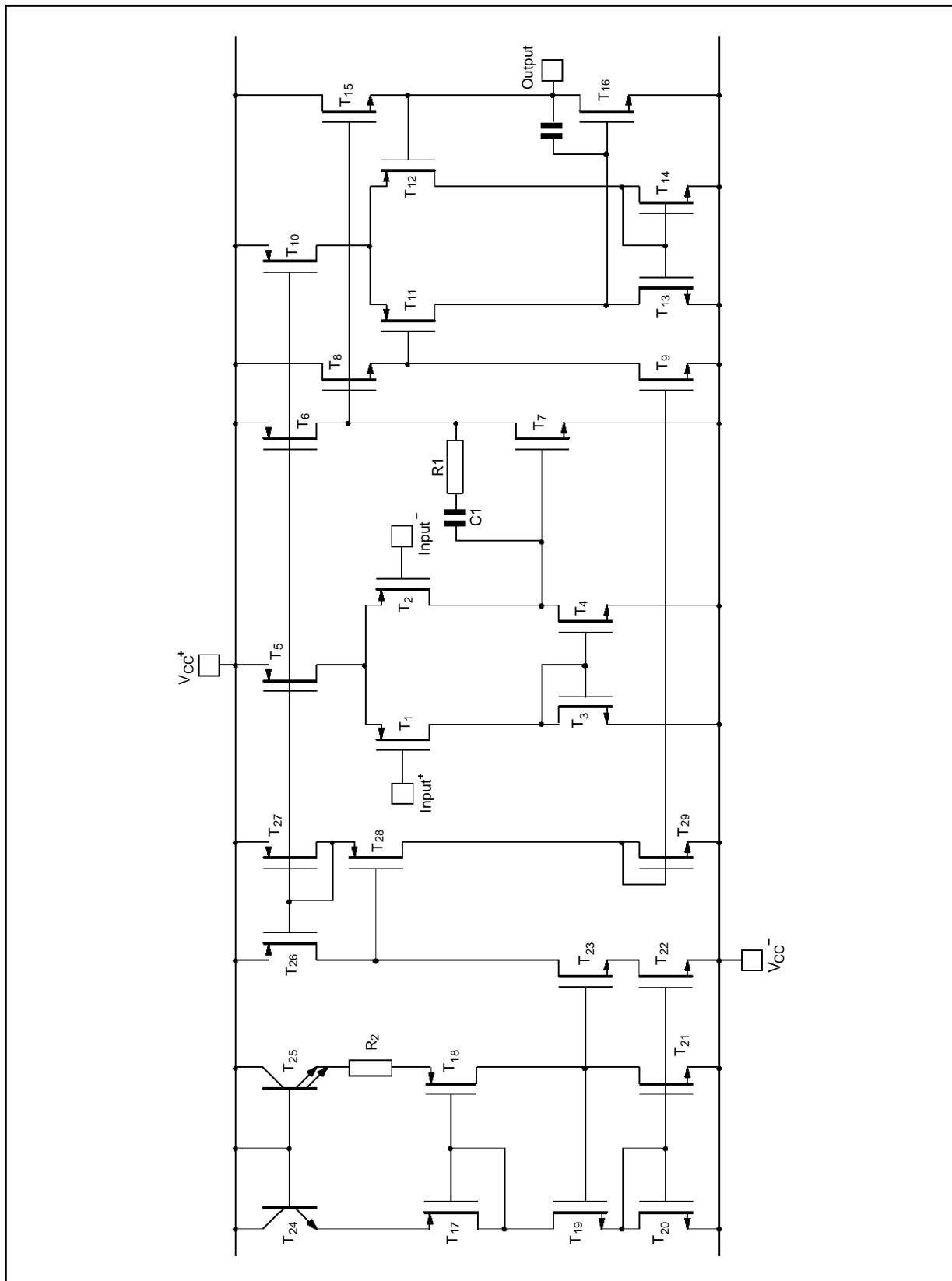
OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V_{CC}^+	Supply Voltage	3 * to 16	V
V_{icm}	Common Mode Input Voltage Range	0 to $V_{CC}^+ - 1.5$	V

27M2-03.TBL

* Selected devices only.

SCHEMATIC DIAGRAM (for 1/2 TS27M2)



27M2-03.EPS

TS27M2C,I,M

ELECTRICAL CHARACTERISTICS

$V_{CC}^+ = +10V$, $V_{CC}^- = 0V$, $T_{amb} = 25^{\circ}C$ (unless otherwise specified)

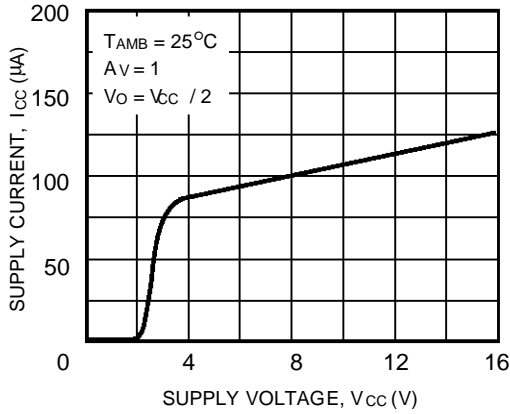
Symbol	Parameter	TS27M2C/AC/BC			TS27M2I/AI/BI TS27M2M/AM/BM			Unit
		Min.	Typ.	Max.	Min.	Typ.	Max.	
V_{io}	Input Offset Voltage $V_O = 1.4V$, $V_{ic} = 0V$ TS27M2C/I/M TS27M2AC/AI/AM TS27M2BC/BI/BM $T_{min.} \leq T_{amb} \leq T_{max.}$ TS27M2C/I/M TS27M2AC/AI/AM TS27M2BC/BI/BM		1.1 0.9 0.25	10 5 2 12 6.5 3		1.1 0.9 0.25	10 5 2 12 6.5 3.5	mV
DV_{io}	Input Offset Voltage Drift		2			2		$\mu V/^{\circ}C$
I_{io}	Input Offset Current - (note 1) $V_{ic} = 5V$, $V_o = 5V$ $T_{min.} \leq T_{amb} \leq T_{max.}$		1	100		1	200	pA
I_{ib}	Input Bias Current - (note 1) $V_{ic} = 5V$, $V_o = 5V$ $T_{min.} \leq T_{amb} \leq T_{max.}$		1	150		1	300	pA
V_{OH}	High Level Output Voltage $V_{id} = 100mV$, $R_L = 100k\Omega$ $T_{min.} \leq T_{amb} \leq T_{max.}$	8.7 8.6	8.9		8.7 8.5	8.9		V
V_{OL}	Low Level Output Voltage $V_{id} = -100mV$			50			50	mV
A_{vd}	Large Signal Voltage Gain $V_o = 1V$ to $6V$, $R_L = 100k\Omega$, $V_{ic} = 5V$ $T_{min.} \leq T_{amb} \leq T_{max.}$	30 20	50		30 10	50		V/mV
GBP	Gain Bandwidth Product $A_v = 40dB$, $R_L = 100k\Omega$, $C_L = 100pF$ $f_{in} = 100kHz$		1			1		MHz
CMR	Common Mode Rejection Ratio $V_o = 1.4V$, $V_{ic} = 1V$ to $7.4V$	65	80		65	80		dB
SVR	Supply Voltage Rejection Ratio $V_{CC}^+ = 5V$ to $10V$, $V_o = 1.4V$	60	80		60	80		dB
I_{CC}	Supply Current (per amplifier) $A_v = 1$, no load, $V_o = 5V$ $T_{min.} \leq T_{amb} \leq T_{max.}$		150	200 250		150	200 300	μA
I_o	Output Short Circuit Current $V_{id} = 100mV$, $V_o = 0V$		60			60		mA
I_{sink}	Output Sink Current $V_{id} = -100mV$, $V_o = V_{CC}$		45			45		mA
SR	Slew-Rate at Unity Gain $R_L = 100k\Omega$, $C_L = 100pF$, $V_i = 3$ to $7V$		0.6			0.6		V/ μs
ϕ_m	Phase Margin at Unity Gain $A_v = 40dB$, $R_L = 100k\Omega$, $C_L = 100pF$		45			45		Degrees
K_{ov}	Overshoot Factor		30			30		%
e_n	Equivalent Input Noise Voltage $f = 1kHz$, $R_S = 100\Omega$		38			38		$\frac{nV}{\sqrt{Hz}}$
V_{O1}/V_{O2}	Channel Separation		120			120		dB

Note : 1. Maximum values including unavoidable inaccuracies of the industrial test.

27M2-04-TBL

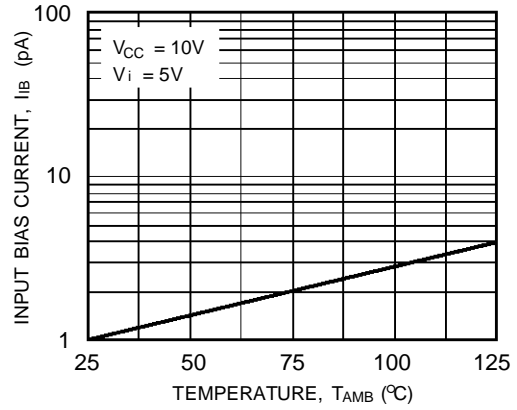
TYPICAL CHARACTERISTICS

Figure 1 : Supply Current (each amplifier) versus Supply Voltage



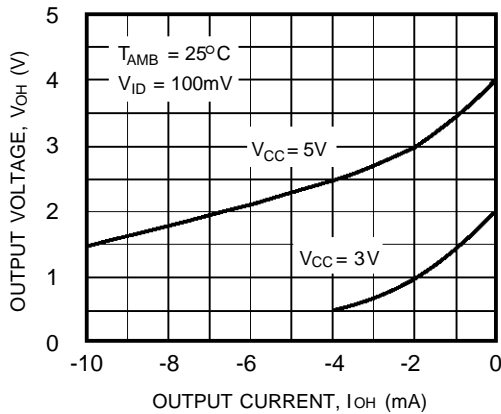
27M2-04.EPS

Figure 2 : Input Bias Current versus Free Air Temperature



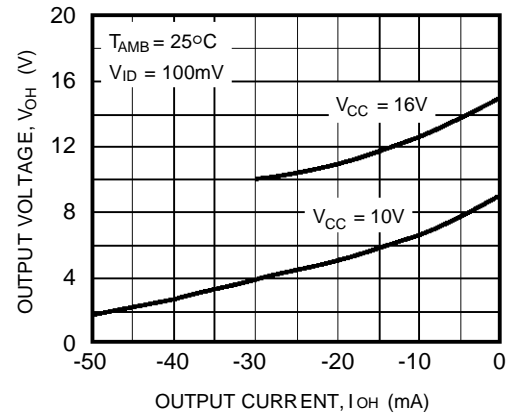
27M2-05.EPS

Figure 3a : High Level Output Voltage versus High Level Output Current



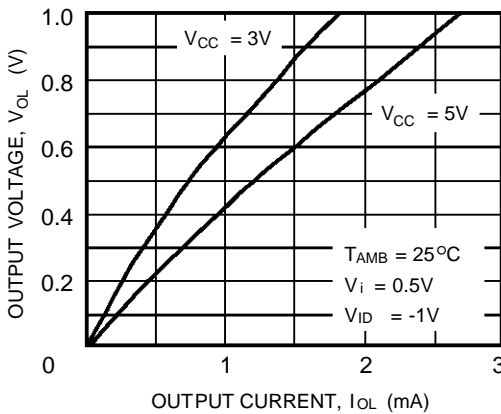
27M2-06.EPS

Figure 3b : High Level Output Voltage versus High Level Output Current



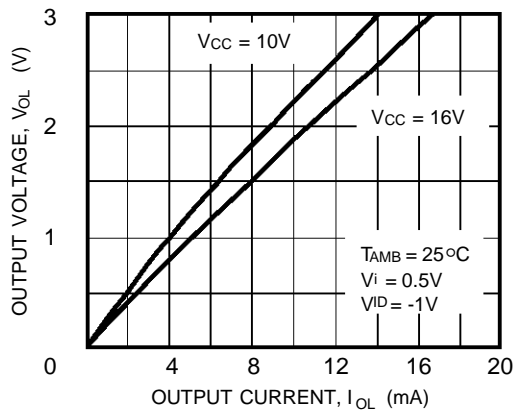
27M2-07.EPS

Figure 3a : Low Level Output Voltage versus Low Level Output Current



27M2-08.EPS

Figure 3b : Low Level Output Voltage versus Low Level Output Current



27M2-09.EPS

TYPICAL CHARACTERISTICS (continued)

Figure 5 : Open Loop Frequency Response and Phase Shift

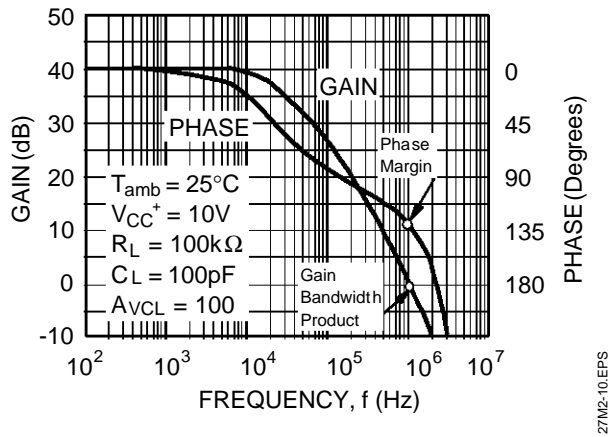


Figure 6 : Gain Bandwidth Product versus Supply Voltage

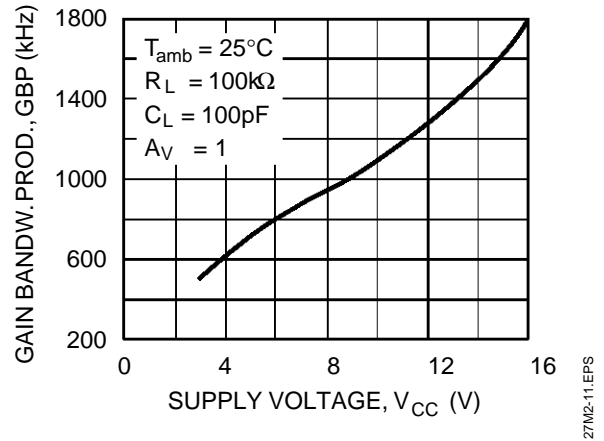


Figure 7 : Phase Margin versus Supply Voltage

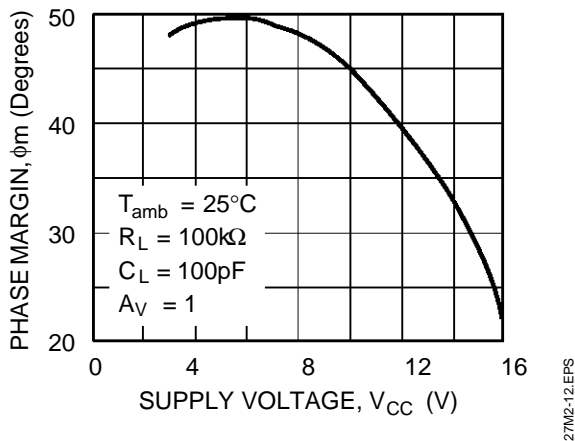


Figure 8 : Phase Margin versus Capacitive Load

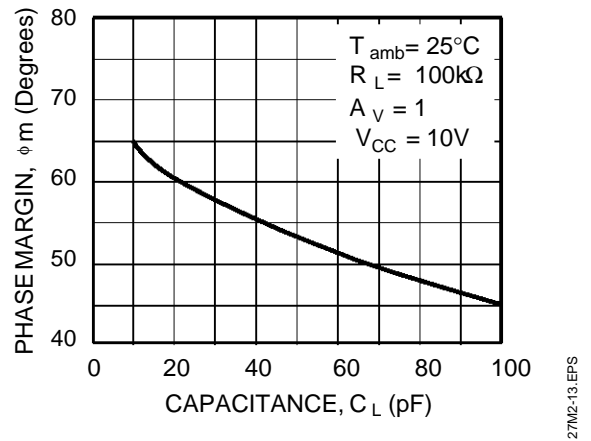


Figure 9 : Slew Rate versus Supply Voltage

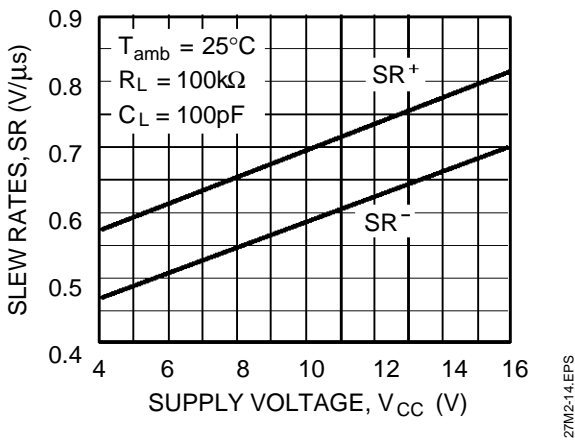
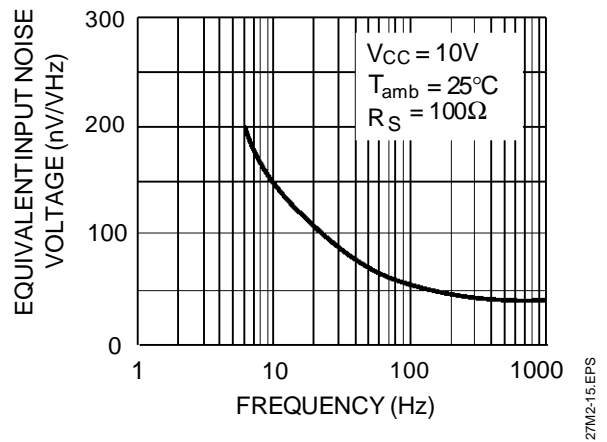
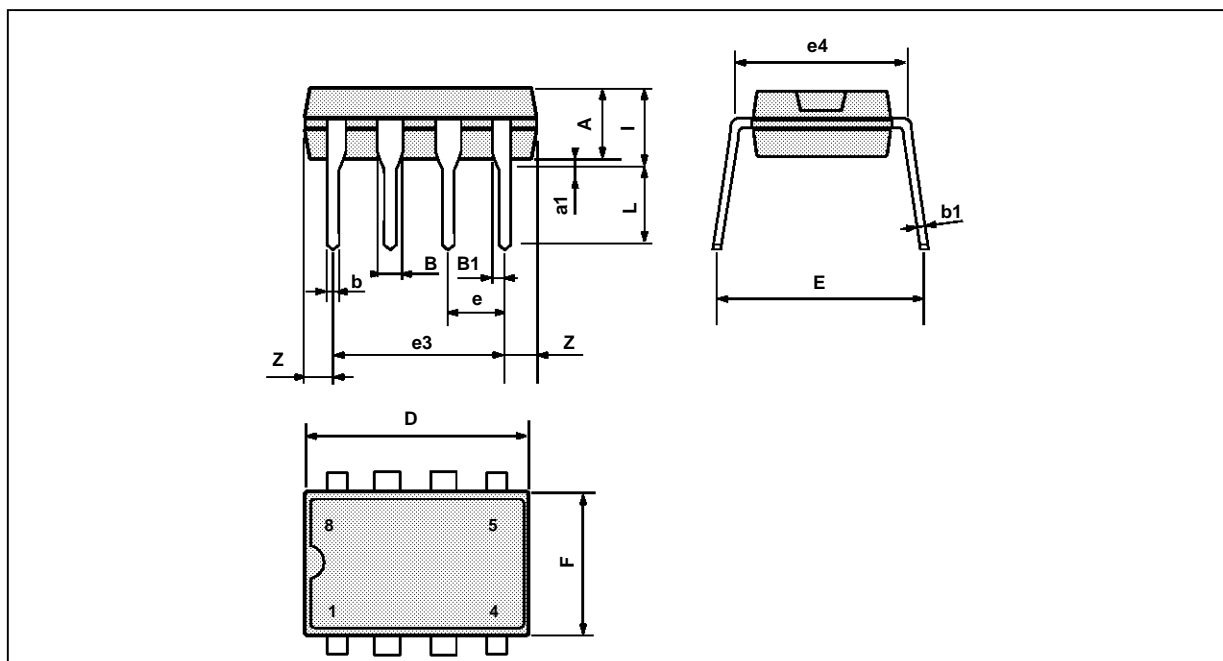


Figure 10 : Input Voltage Noise versus Frequency



PACKAGE MECHANICAL DATA
8 PINS - PLASTIC DIP



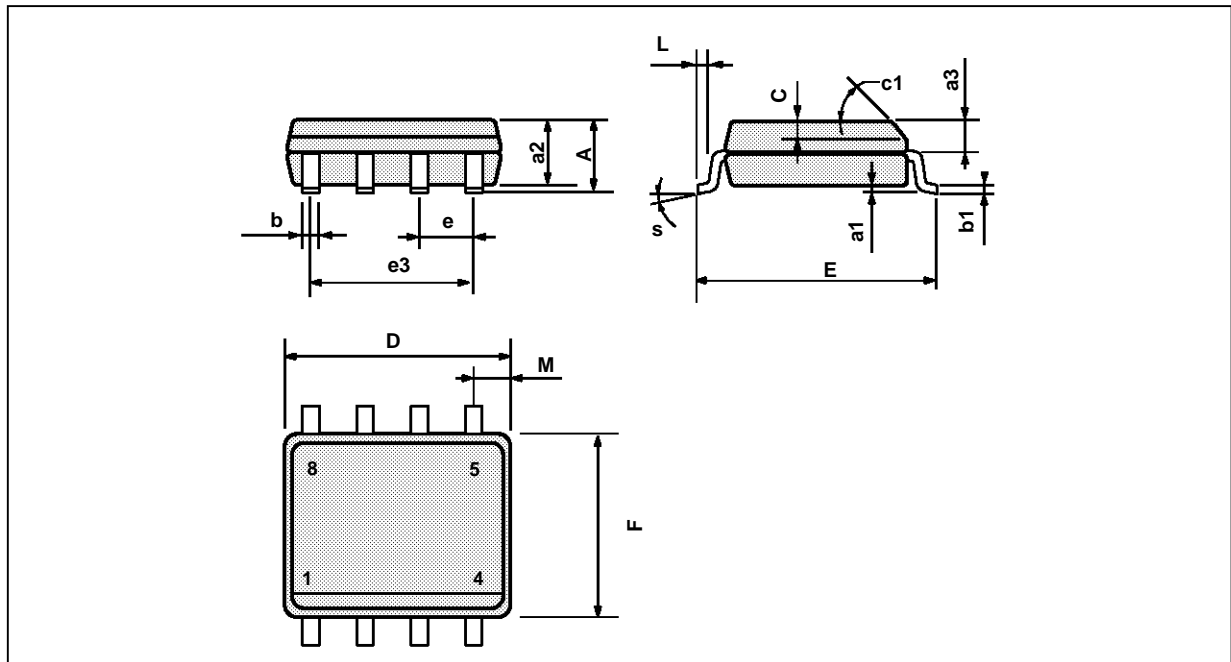
PIN-DIP&EPS

Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A		3.32			0.131	
a1	0.51			0.020		
B	1.15		1.65	0.045		0.065
b	0.356		0.55	0.014		0.022
b1	0.204		0.304	0.008		0.012
D			10.92			0.430
E	7.95		9.75	0.313		0.384
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			6.6			0.260
i			5.08			0.200
L	3.18		3.81	0.125		0.150
Z			1.52			0.060

DIP8:TBL

TS27M2C,I,M

PACKAGE MECHANICAL DATA 8 PINS - PLASTIC MICROPACKAGE (SO)



PIN-SO&EPS

Dimensions	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
a1	0.1		0.25	0.004		0.010
a2			1.65			0.065
a3	0.65		0.85	0.026		0.033
b	0.35		0.48	0.014		0.019
b1	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.020
c1	45° (typ.)					
D	4.8		5.0	0.189		0.197
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.150		0.157
L	0.4		1.27	0.016		0.050
M			0.6			0.024
S	8° (max.)					

SO&TBL

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